10-FY12PMA025M7-P588A78 / 10-PY12PMA025M7-P588A78Y / 10-F112PMA025M7-P588A79

datasheet

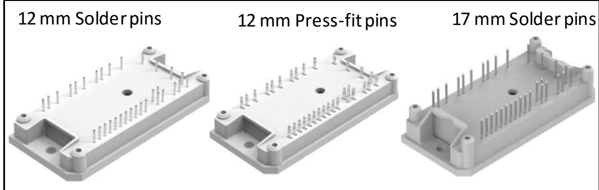
Vincotech

flow **PIM 1** — **1200 V / 25 A**

Features

- IGBT M7 with low V_{CEsat} and improved EMC behavior
- Open emitter configuration
- Compact and low inductive design
- Builtin NTC

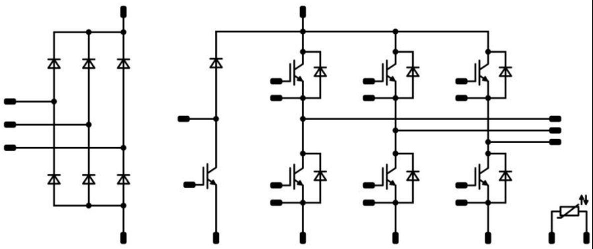
flow 1 housing



Target applications

- Industrial Drives

Schematic



Types

- 10-FY12PMA025M7-P588A78
- 10-PY12PMA025M7-P588A78Y
- 10-F112PMA025M7-P588A79

Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Condition		Value	Unit
Rectifier Diode					
Peak Repetitive Reverse Voltage	V_{RRM}			1600	V
Continuous (direct) forward current	I_F			35	A
Surge (non-repetitive) forward current	I_{FSM}	50 Hz Single Half Sine Wave t_p = 10 ms	T_j = 150 °C	270	A
Surge current capability	I^2t			370	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	64	W
Maximum Junction Temperature	T_{jmax}			150	°C

Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Condition		Value	Unit
Inverter Switch					
Collector-emitter voltage	V_{CES}			1200	V
Collector current	I_C			25	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}		50	A
Total power dissipation	P_{tot}	T_j = T_{jmax}	T_s = 80 °C	82	W
Gate-emitter voltage	V_{GES}			±20	V
Maximum junction temperature	T_{jmax}			175	°C
Inverter Diode					
Peak repetitive reverse voltage	V_{RRM}			1200	V
Continuous (direct) forward current	I_F			25	A
Repetitive peak forward current	I_{FRM}	T_j limited by T_{jmax}		50	A
Total power dissipation	P_{tot}	T_j = T_{jmax}	T_s = 80 °C	62	W
Maximum junction temperature	T_{jmax}			175	°C
Brake Switch					
Collector-emitter voltage	V_{CES}			1200	V
Collector current	I_C			15	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}		30	A
Total power dissipation	P_{tot}	T_j = T_{jmax}	T_s = 80 °C	60	W
Gate-emitter voltage	V_{GES}			±20	V
Maximum junction temperature	T_{jmax}			175	°C
Brake Diode					
Peak repetitive reverse voltage	V_{RRM}			1200	V
Continuous (direct) forward current	I_F			10	A
Repetitive peak forward current	I_{FRM}	T_j limited by T_{jmax}		20	A
Total power dissipation	P_{tot}	T_j = T_{jmax}	T_s = 80 °C	50	W
Maximum junction temperature	T_{jmax}			175	°C

Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Condition		Value	Unit
Module Properties					
Thermal Properties					
Storage temperature	T_{stg}			-40…+125	°C
Operation temperature under switching condition	T_{jop}			-40…(T_{jmax} - 25)	°C
Isolation Properties					
Isolation voltage	V_{isol}	DC Test Voltage*	t_p = 2 s	6000	V
		AC Voltage	t_p = 1 min	2500	V
Creepage distance		for 12 mm solder pins		min. 12,7	mm
		for 12 mm press-fit pins			
		for 17 mm solder pins			
Clearance		for 12 mm solder pins		7,91	mm
		for 12 mm press-fit pins		7,96	
		for 17 mm solder pins		min. 12,7	
Comparative Tracking Index	CTI			> 200	

*100 % tested in production

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Rectifier Diode										
Static										
Forward voltage	V_F				35	25 125	0,8	1,17 1,13	1,6	V
Reverse leakage current	I_r			1600		25 145			50 1100	µA
Thermal										
Thermal resistance junction to sink	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,10		K/W

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Inverter Switch										
Static										
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0025	25	5,4	6	6,6	V
Collector-emitter saturation voltage	V_{CEsat}		15		25	25 125 150		1,65 1,89 1,95	1,95	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			70	µA
Gate-emitter leakage current	I_{GES}		20	0		25			500	nA
Input capacitance	C_{ies}							4800		
Output capacitance	C_{oes}		0	10		25		170		pF
Reverse transfer capacitance	C_{res}							57		
Gate charge	Q_g		15	600	25	25		180		nC
Thermal										
Thermal resistance junction to sink	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,16		K/W
Dynamic										
Turn-on delay time	$t_{d(on)}$	R_{goff} = 16 Ω R_{gon} = 16 Ω	±15	600	25	25 125 150		147 149 145		ns
Rise time	t_r					25 125 150		29 33 34		
Turn-off delay time	$t_{d(off)}$					25 125 150		171 191 196		
Fall time	t_f					25 125 150		95 110 115		
Turn-on energy (per pulse)	E_{on}	Q_{rFWD} = 2,5 µC Q_{rFWD} = 3,9 µC Q_{rFWD} = 4,3 µC				25 125 150		2,06 2,66 2,82		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		1,67 2,18 2,29		

Characteristic Values

Parameter	Symbol	Conditions	V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	Unit
Inverter Diode										
Static										
Forward voltage	V_F				25	25 125 150		1,63 1,70 1,69	2,1	V
Reverse leakage current	I_R			1200		25			35	µA
Thermal										
Thermal resistance junction to sink	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,54		K/W
Dynamic										
Peak recovery current	I_{RRM}	di/dt = 645 A/µs di/dt = 673 A/µs di/dt = 633 A/µs	±15	600	25	25 125 150		21 23 23		A
Reverse recovery time	t_{rr}					25 125 150		254 367 404		ns
Recovered charge	Q_r					25 125 150		2,54 3,88 4,28		µC
Reverse recovered energy	E_{rec}					25 125 150		0,88 1,45 1,61		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		217 134 132		A/µs

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Brake Switch										
Static										
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0015	25	5,4	6	6,6	V
Collector-emitter saturation voltage	V_{CEsat}		15		15	25 125 150		1,70 1,95 2,01	1,95	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			60	µA
Gate-emitter leakage current	I_{GES}		20	0		25			500	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}		0	10		25		2900		pF
Output capacitance	C_{oes}		0	10		25		120		pF
Reverse transfer capacitance	C_{res}		0	10		25		34		pF
Gate charge	Q_g		15	600	15	25		1100		nC
Thermal										
Thermal resistance junction to sink	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,60		K/W
Dynamic										
Turn-on delay time	$t_{d(on)}$	R_{goff} = 32 Ω R_{gon} = 32 Ω	15/0	700	15	25 125 150		293 257 246		ns
Rise time	t_r	R_{goff} = 32 Ω R_{gon} = 32 Ω	15/0	700	15	25 125 150		185 200 203		ns
Turn-off delay time	$t_{d(off)}$	R_{goff} = 32 Ω R_{gon} = 32 Ω	15/0	700	15	25 125 150		398 442 450		ns
Fall time	t_f	R_{goff} = 32 Ω R_{gon} = 32 Ω	15/0	700	15	25 125 150		66 88 92		ns
Turn-on energy (per pulse)	E_{on}	Q_{rFWD} = 1,1 µC Q_{rFWD} = 1,9 µC Q_{rFWD} = 2,1 µC	15/0	700	15	25 125 150		2,95 3,57 3,74		mWs
Turn-off energy (per pulse)	E_{off}		15/0	700	15	25 125 150		1,33 1,71 1,81		mWs

Characteristic Values

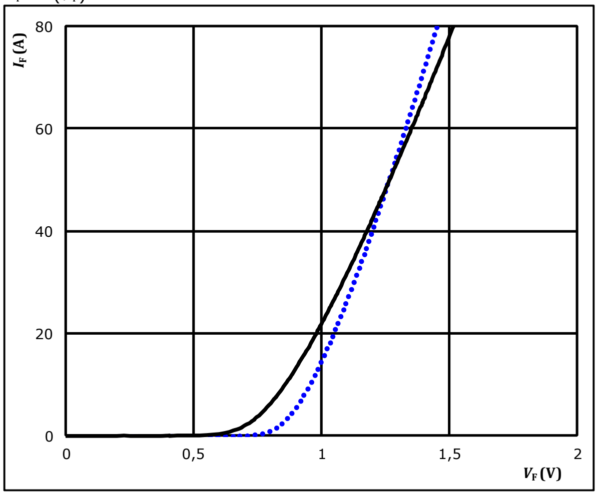
Parameter	Symbol	Conditions					Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Brake Diode										
Static										
Forward voltage	V_F				10	25 125 150		1,61 1,69 1,69	2,1	V
Reverse leakage current	I_R			1200		25			25	µA
Thermal										
Thermal resistance junction to sink	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,91		K/W
Dynamic										
Peak recovery current	I_{RRM}					25 125 150		6 7 7		A
Reverse recovery time	t_{rr}					25 125 150		295 485 544		ns
Recovered charge	Q_r	di/dt = 69 A/µs di/dt = 69 A/µs di/dt = 67 A/µs	15/0	700	15	25 125 150		1,140 1,882 2,120		µC
Reverse recovered energy	E_{rec}					25 125 150		0,422 0,781 0,895		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		44 29 25		A/µs
Thermistor										
Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	R_{100} = 1484 Ω				100	-5		5	%
Power dissipation	P					25		5		mW
Power dissipation constant						25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %				25		3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %				25		4000		K
Vincotech NTC Reference									I	

Rectifier Diode Characteristics

figure 1. **Rectifier Diode**

Typical forward characteristics

$I_F = f(V_F)$



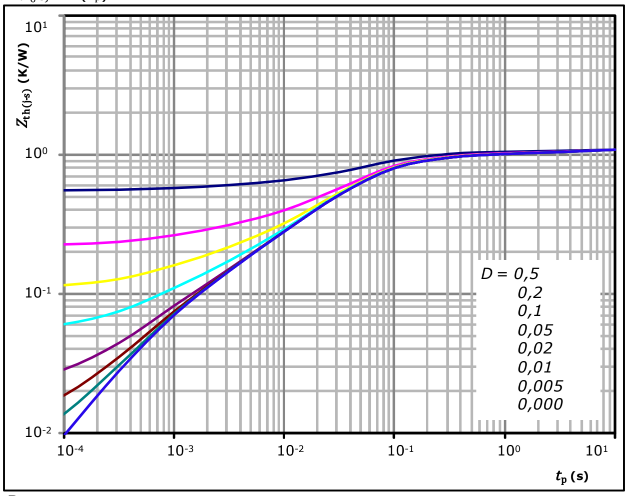
t_p = 250 µs

T_j: 25 °C; 125 °C

figure 2. **Rectifier Diode**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



D = t_p / T

$R_{th(j-s)}$ = 1,10 K/W

Diode thermal model values

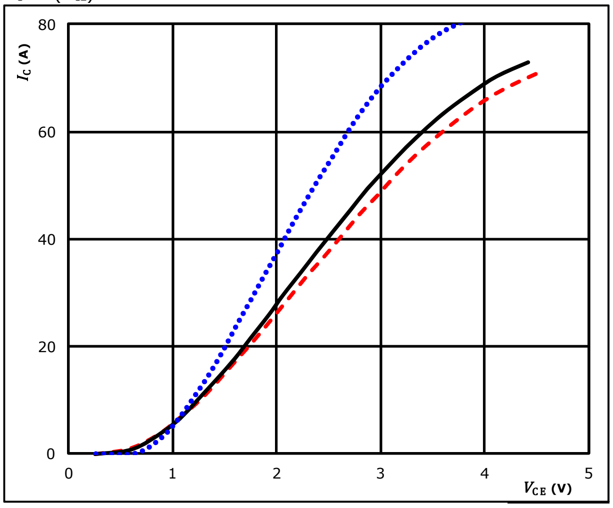
R (K/W)	τ (s)
1,03E-01	7,70E+00
1,17E-01	4,31E-01
5,19E-01	6,42E-02
2,38E-01	2,35E-02
7,64E-02	3,81E-03
4,71E-02	7,57E-04

Inverter Switch Characteristics

figure 1. **IGBT**

Typical output characteristics

$I_C = f(V_{CE})$

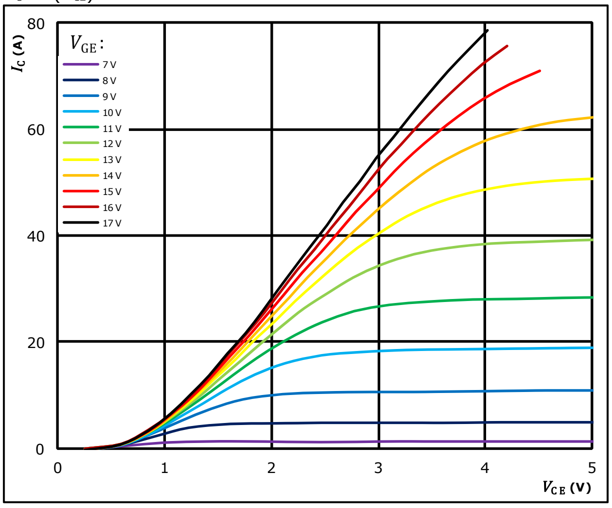


t_p =	250	µs		25 °C	dotted
V_{GE} =	15	V	T_j:	125 °C	solid
				150 °C	dashed

figure 2. **IGBT**

Typical output characteristics

$I_C = f(V_{CE})$



t_p = 250 µs

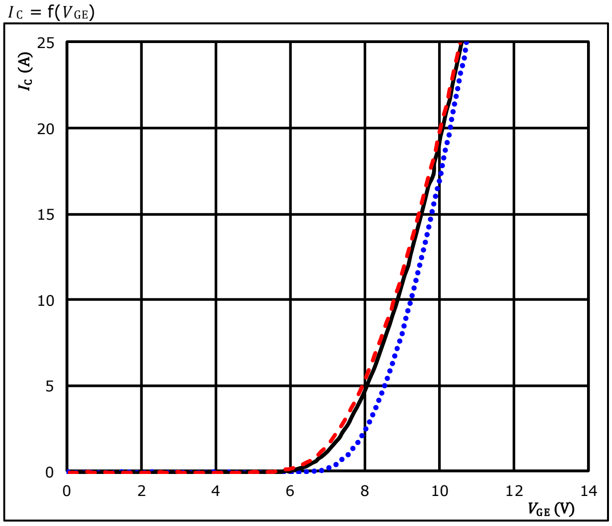
T_j = 125 °C

V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. **IGBT**

Typical transfer characteristics

$I_C = f(V_{GE})$

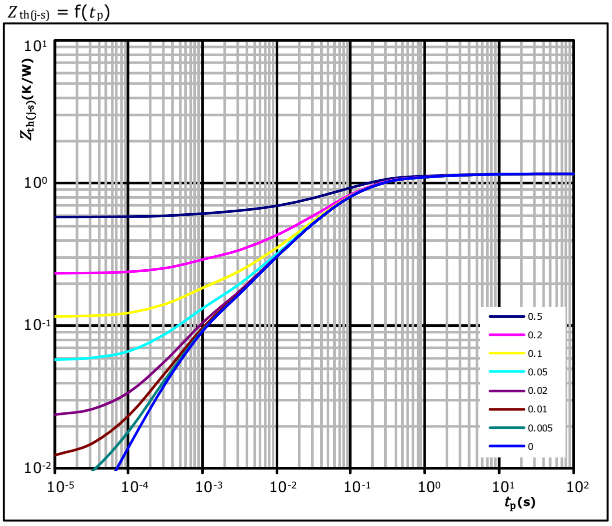


t_p =	100	µs		25 °C	dotted
V_{CE} =	10	V	T_j:	125 °C	solid
				150 °C	dashed

figure 4. **IGBT**

Transient thermal impedance as function of pulse duration

$Z_{th(j\text{-}s)} = f(t_p)$



D = t_p / T

$R_{th(j\text{-}s)}$ = 1,16 K/W

IGBT thermal model values

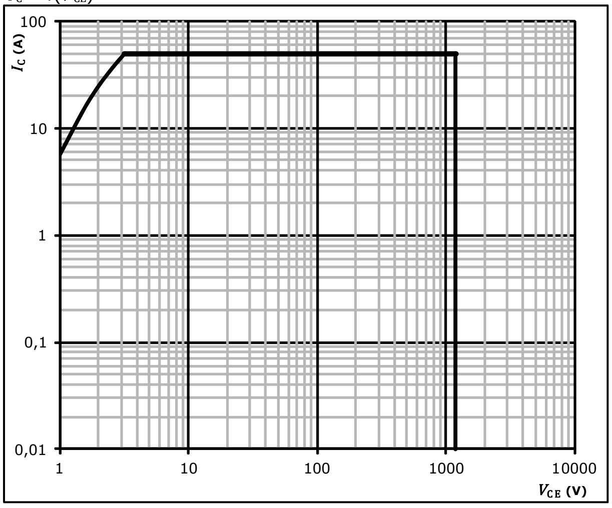
R (K/W)	τ (s)
5,33E-02	3,54E+00
1,07E-01	5,75E-01
5,05E-01	1,04E-01
2,68E-01	3,30E-02
1,51E-01	7,35E-03
7,80E-02	6,52E-04

Inverter Switch Characteristics

figure 5. **IGBT**

Safe operating area

$I_C = f(V_{CE})$



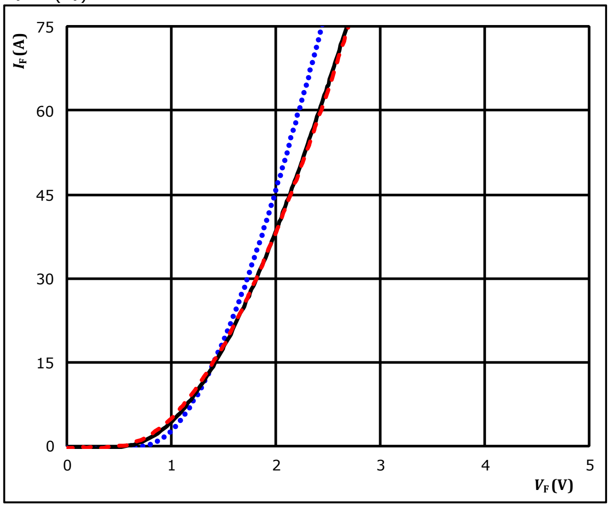
D =	single pulse	
T_s =	80	ºC
V_{GE} =	±15	V
T_j =	T_{jmax}	

Inverter Diode Characteristics

figure 1. **FWD**

Typical forward characteristics

$I_F = f(V_F)$



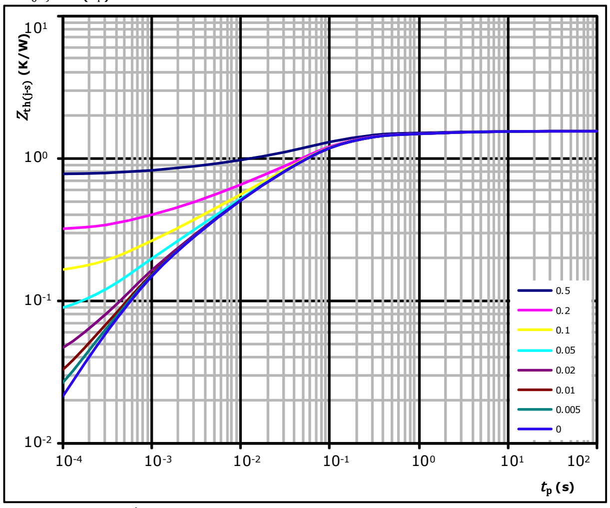
t_p = 250 µs

T_j: 25 °C, 125 °C, 150 °C

figure 2. **FWD**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$

$R_{th(j-s)}$ = 1,54 K/W

FWD thermal model values

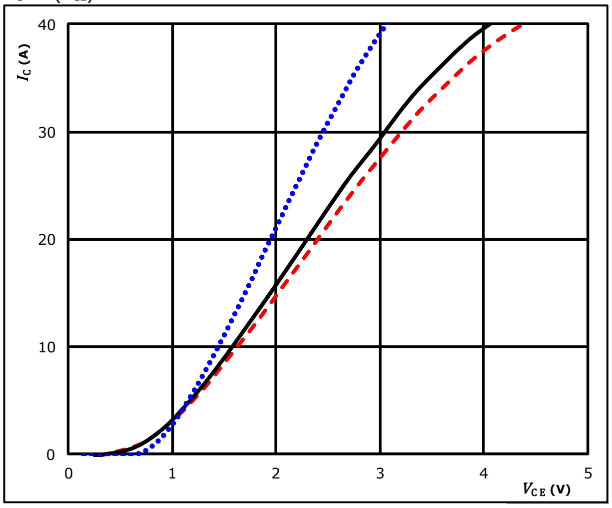
R (K/W)	τ (s)
4,69E-02	5,05E+00
1,06E-01	7,09E-01
5,57E-01	1,01E-01
4,68E-01	3,22E-02
2,35E-01	5,52E-03
8,77E-02	1,01E-03
4,01E-02	5,52E-04

Brake Switch Characteristics

figure 1. **IGBT**

Typical output characteristics

$I_C = f(V_{CE})$

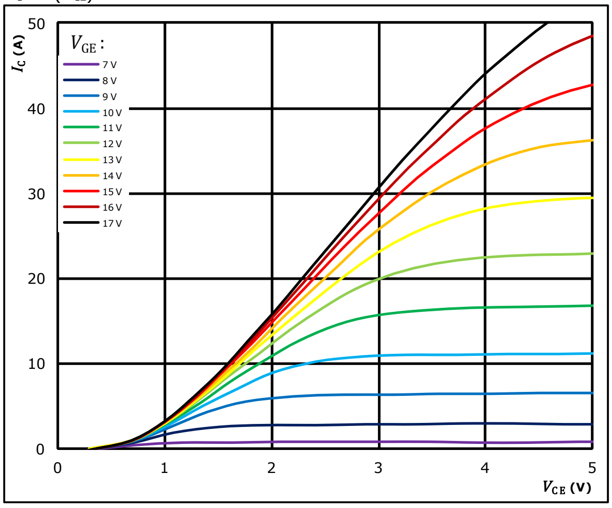


t_p = 250 µs
V_{GE} = 15 V
T_j: 25 °C, 125 °C, 150 °C

figure 2. **IGBT**

Typical output characteristics

$I_C = f(V_{CE})$

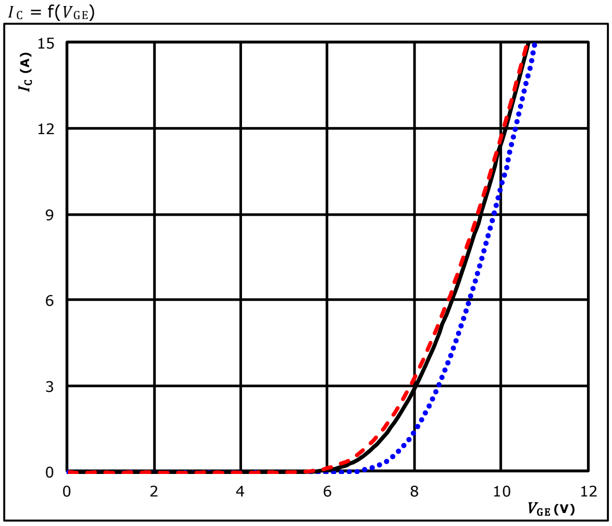


t_p = 250 µs
T_j = 150 °C
V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. **IGBT**

Typical transfer characteristics

$I_C = f(V_{GE})$

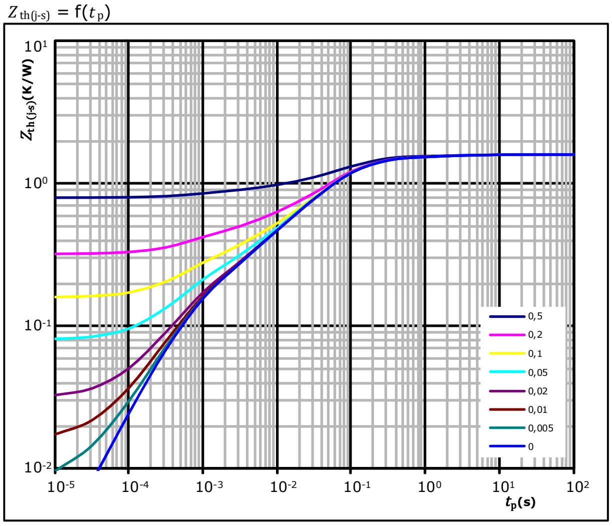


t_p = 100 µs
V_{CE} = 10 V
T_j: 25 °C, 125 °C, 150 °C

figure 4. **IGBT**

Transient thermal impedance as function of pulse duration

$Z_{th(j\text{-}s)} = f(t_p)$



D = t_p / T
$R_{th(j\text{-}s)}$ = 1,60 K/W

IGBT thermal model values

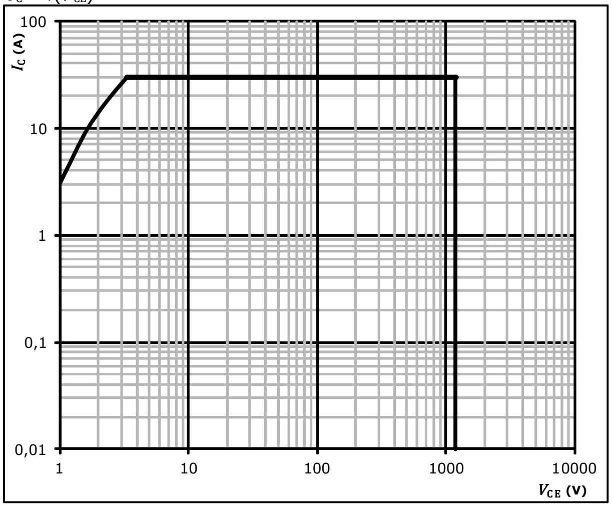
R (K/W)	τ (s)
4,90E-02	4,40E+00
1,40E-01	5,34E-01
8,04E-01	8,02E-02
2,98E-01	2,57E-02
1,69E-01	5,09E-03
1,35E-01	6,41E-04

Brake Switch Characteristics

figure 5. **IGBT**

Safe operating area

$I_C = f(V_{CE})$



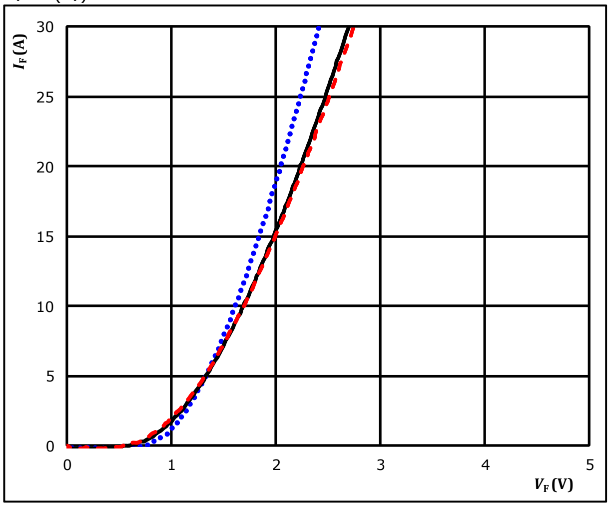
D =	single pulse	
T_s =	80	ºC
V_{GE} =	±15	V
T_j =	T_{jmax}	

Brake Diode Characteristics

figure 1. **FWD**

Typical forward characteristics

$I_F = f(V_F)$



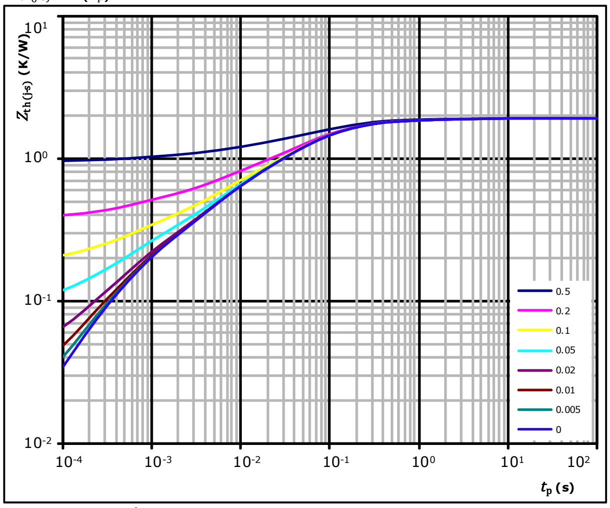
t_p = 250 μs

T_j: 25 °C, 125 °C, 150 °C

figure 2. **FWD**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$

$R_{th(j-s)}$ = 1,91 K/W

FWD thermal model values

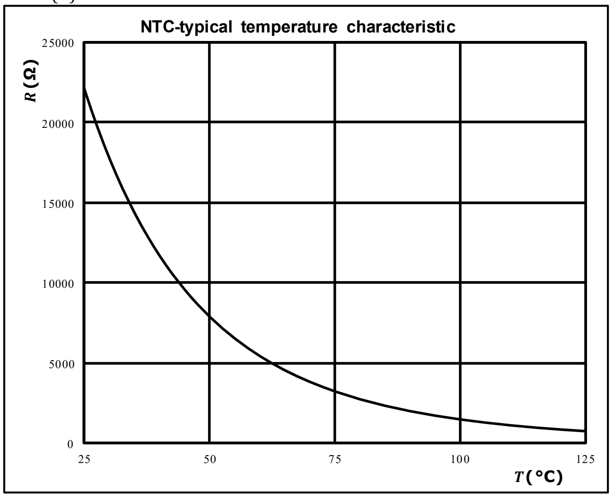
R (K/W)	τ (s)
9,38E-02	2,25E+00
3,43E-01	2,12E-01
8,53E-01	5,82E-02
3,59E-01	9,80E-03
1,37E-01	2,88E-03
1,26E-01	4,78E-04

Thermistor Characteristics

figure 1.	Thermistor

Typical NTC characteristic as a function of temperature

$R = f(T)$

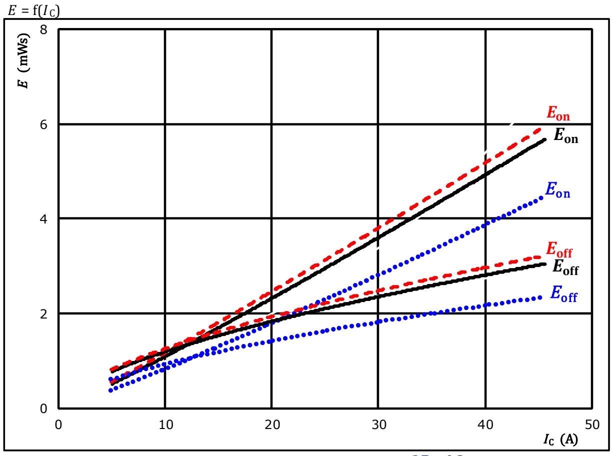


Inverter Switching Characteristics

figure 1. **IGBT**

Typical switching energy losses as a function of collector current

$E = f(I_C)$



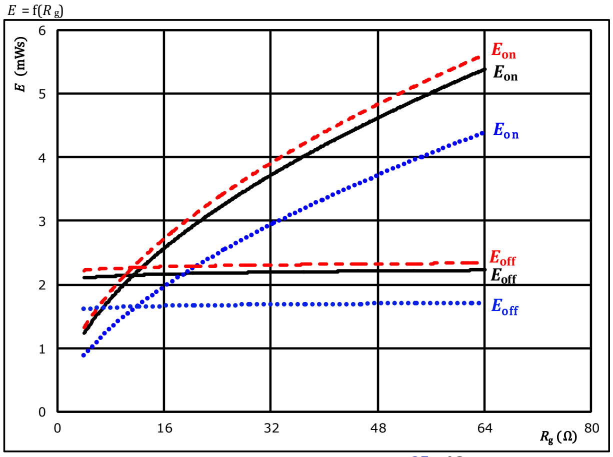
With an inductive load at

V_{CE} =	600	V	T_j:	25 °C	dotted
V_{GE} =	±15	V		125 °C	solid
R_{gon} =	16	Ω		150 °C	dashed
R_{goff} =	16	Ω			

figure 2. **IGBT**

Typical switching energy losses as a function of gate resistor

$E = f(R_g)$



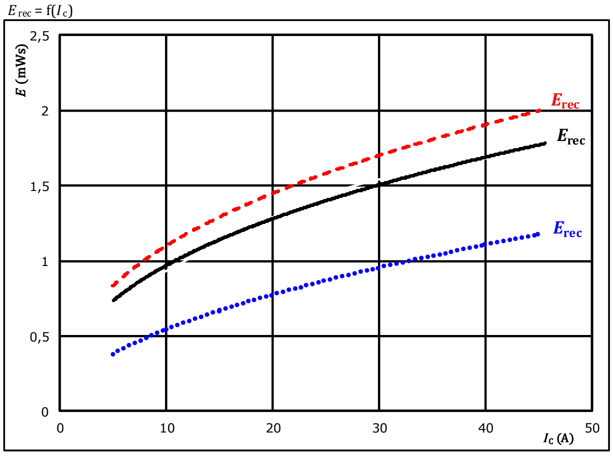
With an inductive load at

V_{CE} =	600	V	T_j:	25 °C	dotted
V_{GE} =	±15	V		125 °C	solid
I_C =	25	A		150 °C	dashed

figure 3. **FWD**

Typical reverse recovered energy loss as a function of collector current

$E_{rec} = f(I_c)$



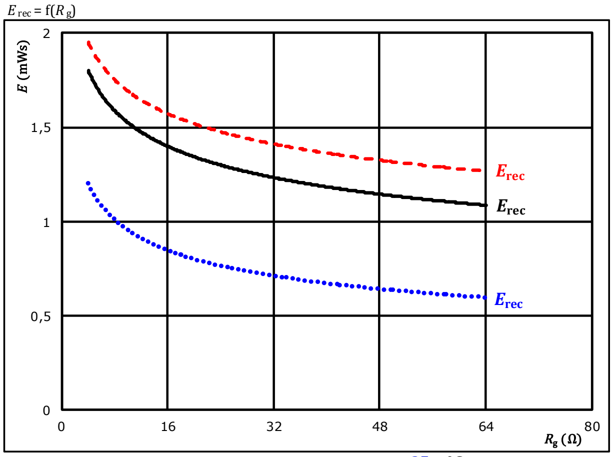
With an inductive load at

V_{CE} =	600	V	T_j:	25 °C	dotted
V_{GE} =	±15	V		125 °C	solid
R_{gon} =	16	Ω		150 °C	dashed

figure 4. **FWD**

Typical reverse recovered energy loss as a function of gate resistor

$E_{rec} = f(R_g)$



With an inductive load at

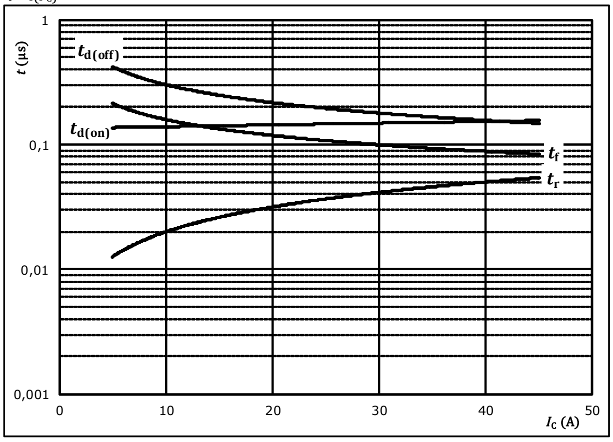
V_{CE} =	600	V	T_j:	25 °C	dotted
V_{GE} =	±15	V		125 °C	solid
I_C =	25	A		150 °C	dashed

Inverter Switching Characteristics

figure 5. **IGBT**

Typical switching times as a function of collector current

$t = f(I_C)$



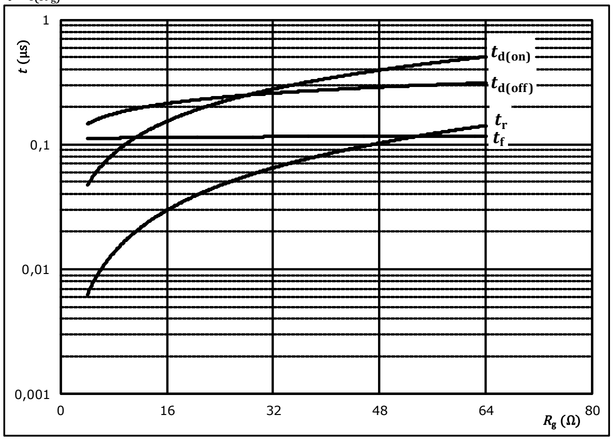
With an inductive load at

T_j =	150	°C
V_{CE} =	600	V
V_{GE} =	±15	V
R_{gon} =	16	Ω
R_{goff} =	16	Ω

figure 6. **IGBT**

Typical switching times as a function of gate resistor

$t = f(R_g)$



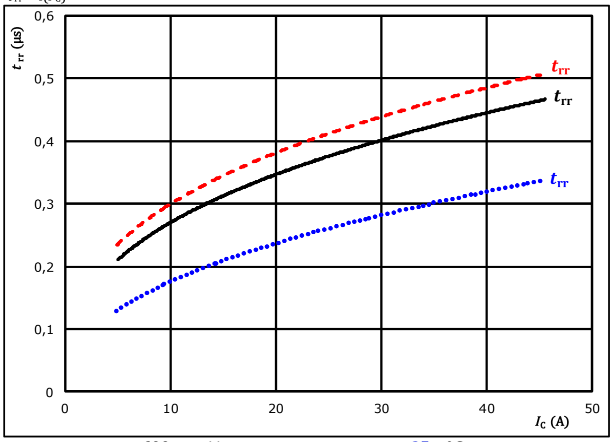
With an inductive load at

T_j =	150	°C
V_{CE} =	600	V
V_{GE} =	±15	V
I_C =	25	A

figure 7. **FWD**

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$

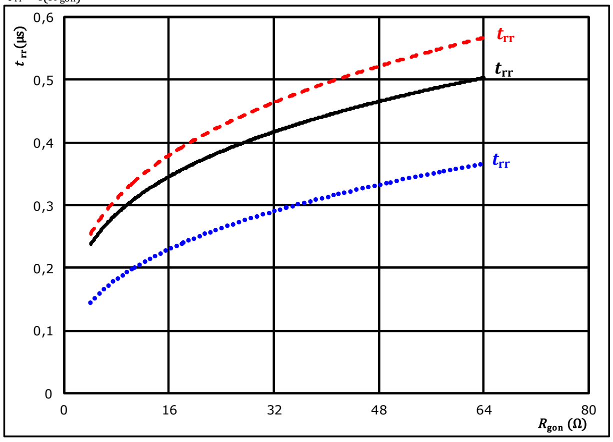


At					
V_{CE} =	600	V	T_j:	25 °C	············
V_{GE} =	±15	V		125 °C	———
R_{gon} =	16	Ω		150 °C	– – –

figure 8. **FWD**

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



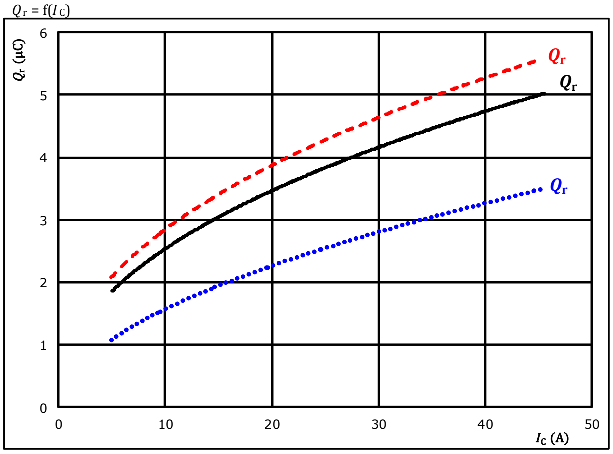
At					
V_{CE} =	600	V	T_j:	25 °C	············
V_{GE} =	±15	V		125 °C	———
I_C =	25	A		150 °C	– – –

Inverter Switching Characteristics

figure 9. **FWD**

Typical recovered charge as a function of collector current

$Q_r = f(I_C)$

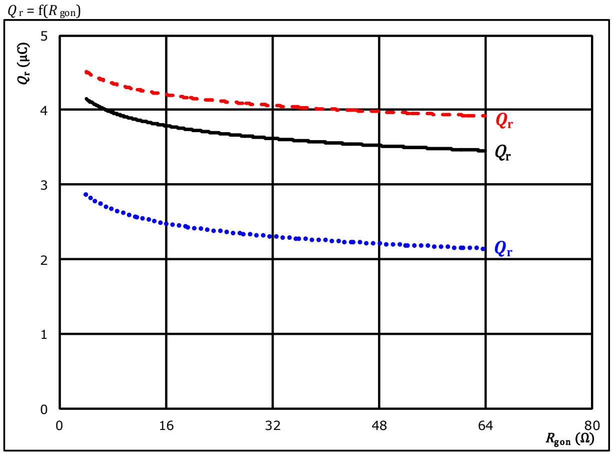


At					
V_{CE} =	600	V		25 °C	············
V_{GE} =	±15	V	T_j:	125 °C	———
R_{gon} =	16	Ω		150 °C	– – –

figure 10. **FWD**

Typical recovered charge as a function of IGBT turn on gate resistor

$Q_r = f(R_{gon})$

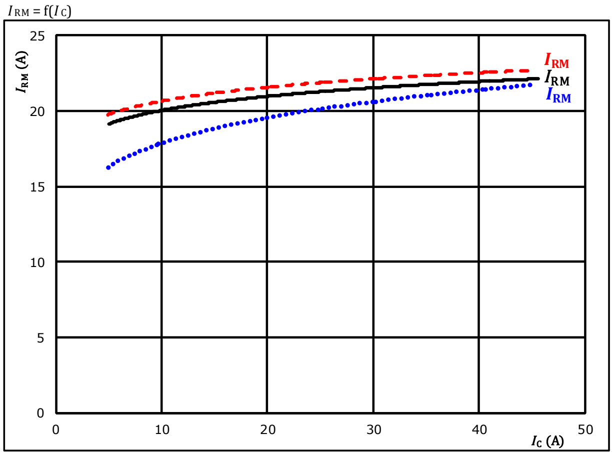


At					
V_{CE}=	600	V		25 °C	············
V_{GE} =	±15	V	T_j:	125 °C	———
I_C=	25	A		150 °C	– – –

figure 11. **FWD**

Typical peak reverse recovery current current as a function of collector current

$I_{RM} = f(I_C)$

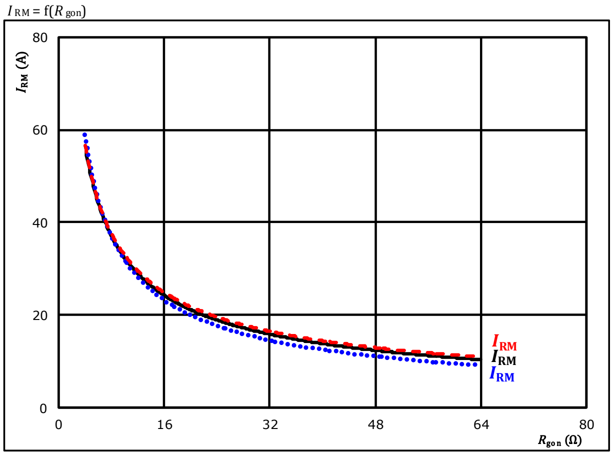


At					
V_{CE} =	600	V		25 °C	············
V_{GE} =	±15	V	T_j:	125 °C	———
R_{gon} =	16	Ω		150 °C	– – –

figure 12. **FWD**

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$I_{RM} = f(R_{gon})$



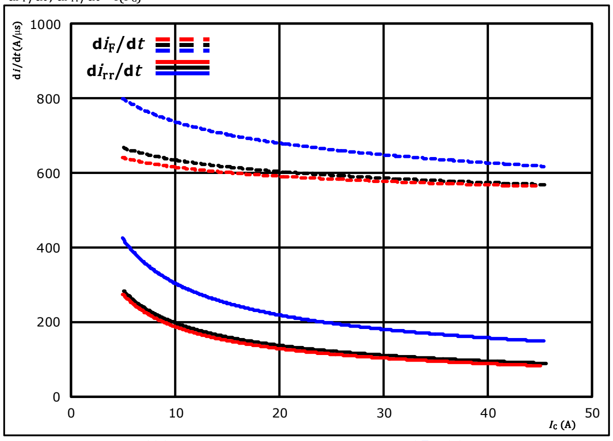
At					
V_{CE} =	600	V		25 °C	············
V_{GE} =	±15	V	T_j:	125 °C	———
I_C =	25	A		150 °C	– – –

Inverter Switching Characteristics

figure 13. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_F/dt, di_{rr}/dt = f(I_C)$

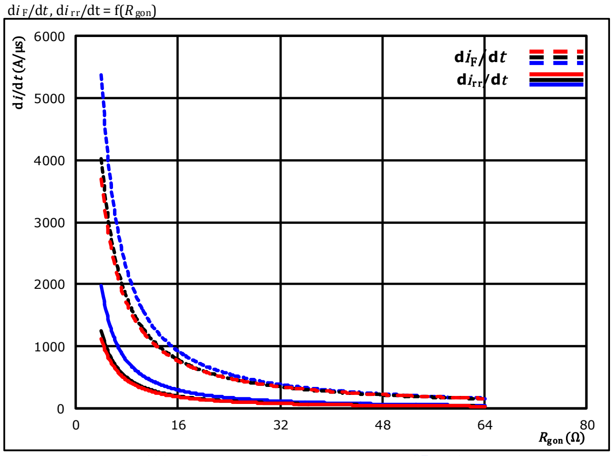


At					
V_{CE} =	600	V		25 °C	dotted
V_{GE} =	±15	V	T_j:	125 °C	solid
R_{gon} =	16	Ω		150 °C	dashed

figure 14. FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$di_F/dt, di_{rr}/dt = f(R_{gon})$

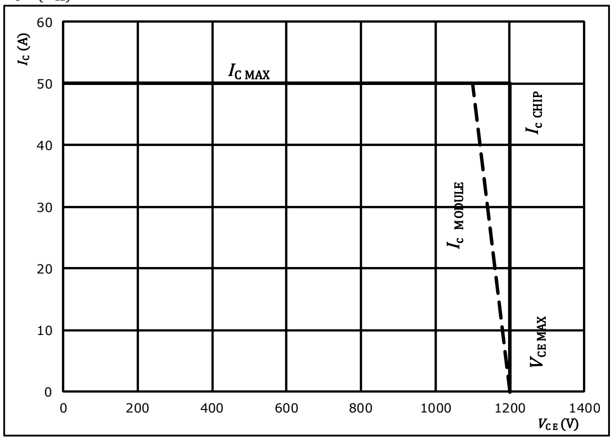


At					
V_{CE} =	600	V		25 °C	dotted
V_{GE} =	±15	V	T_j:	125 °C	solid
I_C=	25	A		150 °C	dashed

figure 15. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At

T_j =	175	°C
R_{gon} =	16	Ω
R_{goff} =	16	Ω

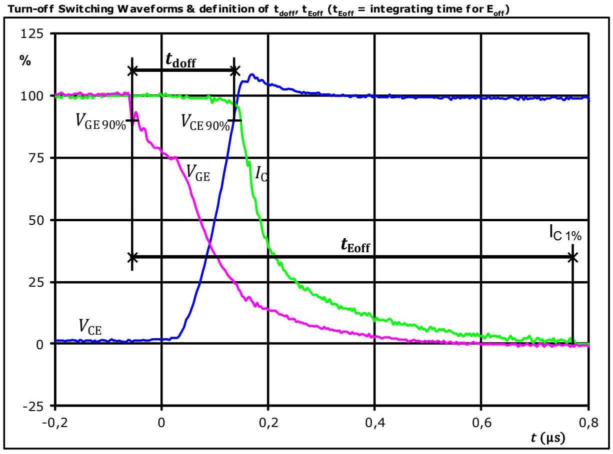
Inverter Switching Definitions

General conditions

T_j	=	125 °C
R_{gon}	=	16 Ω
R_{goff}	=	16 Ω

figure 1. **IGBT**

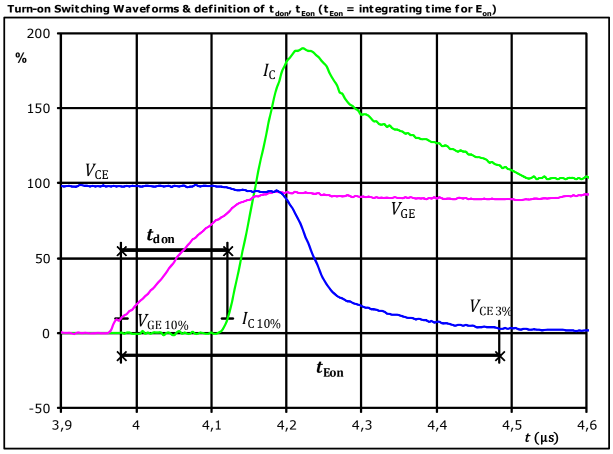
Turn-off Switching Waveforms & definition of t_{doff}, t_{Eoff} (t_{Eoff} = integrating time for E_{off})



$V_{GE}(0\%)$ =	-15	V
$V_{GE}(100\%)$ =	15	V
$V_C(100\%)$ =	600	V
$I_C(100\%)$ =	25	A
t_{doff} =	0,191	µs
t_{Eoff} =	0,826	µs

figure 2. **IGBT**

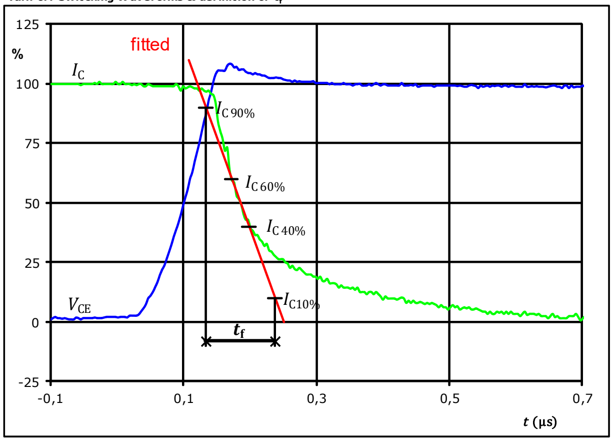
Turn-on Switching Waveforms & definition of t_{don}, t_{Eon} (t_{Eon} = integrating time for E_{on})



$V_{GE}(0\%)$ =	-15	V
$V_{GE}(100\%)$ =	15	V
$V_C(100\%)$ =	600	V
$I_C(100\%)$ =	25	A
t_{don} =	0,149	µs
t_{Eon} =	0,504	µs

figure 3. **IGBT**

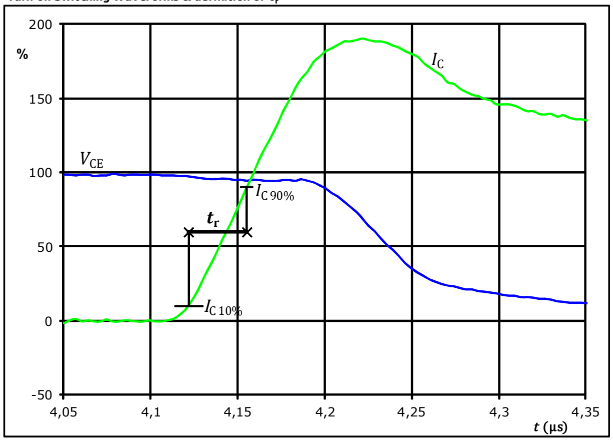
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%)$ =	600	V
$I_C(100\%)$ =	25	A
t_f =	0,110	µs

figure 4. **IGBT**

Turn-on Switching Waveforms & definition of t_r

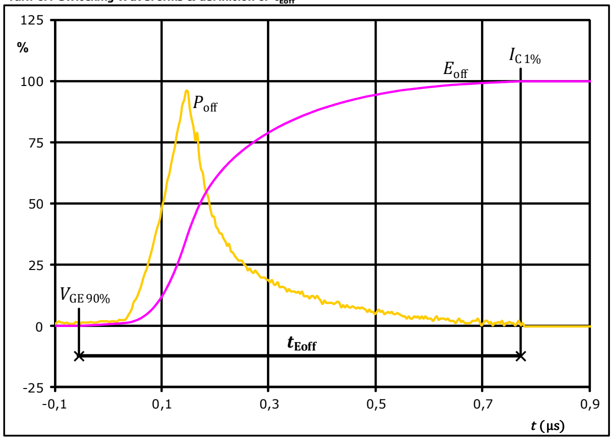


$V_C(100\%)$ =	600	V
$I_C(100\%)$ =	25	A
t_r =	0,033	µs

Inverter Switching Characteristics

figure 5. IGBT

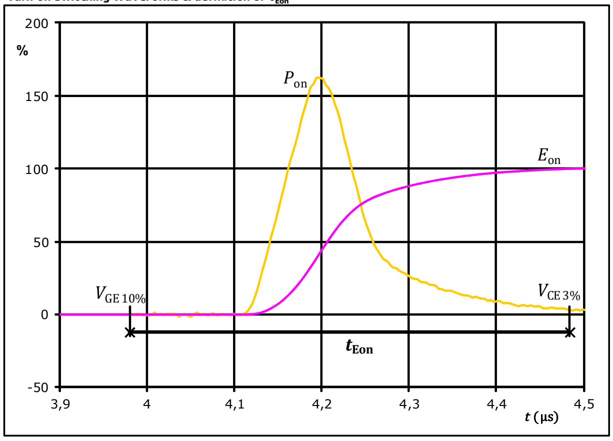
Turn-off Switching Waveforms & definition of t_{Eoff}



P_{off} (100%) =	15,13	kW
E_{off} (100%) =	2,18	mJ
t_{Eoff} =	0,83	µs

figure 6. IGBT

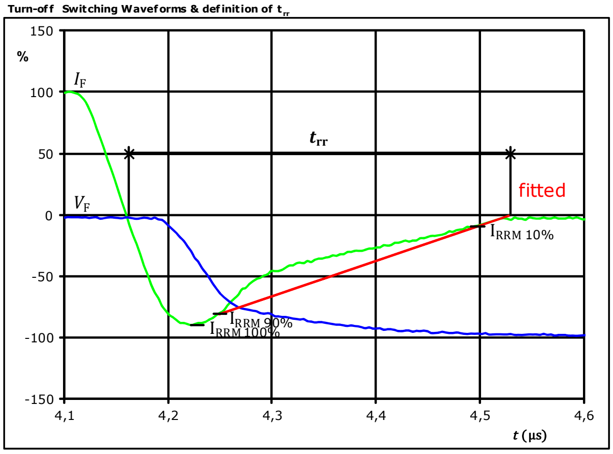
Turn-on Switching Waveforms & definition of t_{Eon}



P_{on} (100%) =	15,13	kW
E_{on} (100%) =	2,66	mJ
t_{Eon} =	0,50	µs

figure 7. FWD

Turn-off Switching Waveforms & definition of t_{rr}

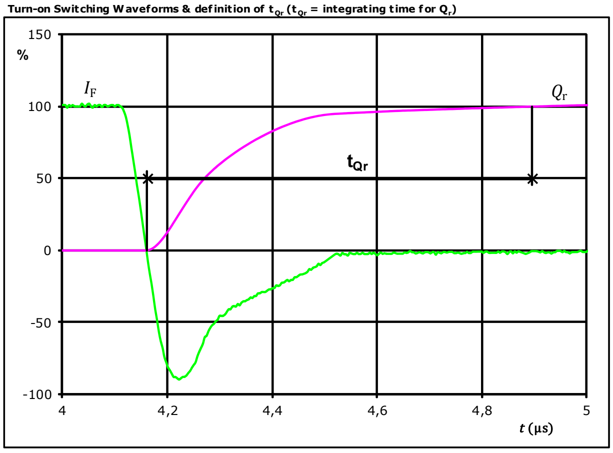


V_F (100%) =	600	V
I_F (100%) =	25	A
I_{RRM} (100%) =	-23	A
t_{rr} =	0,367	µs

Inverter Switching Characteristics

figure 8. **FWD**

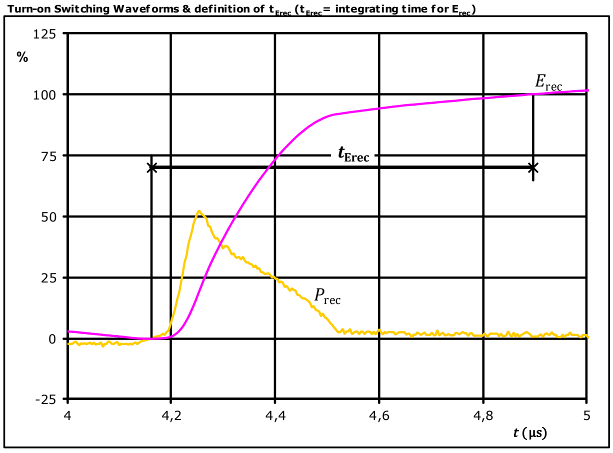
Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)



I_F (100%) =	25	A
Q_r (100%) =	3,88	µC
t_{Qr} =	0,73	µs

figure 9. **FWD**

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})



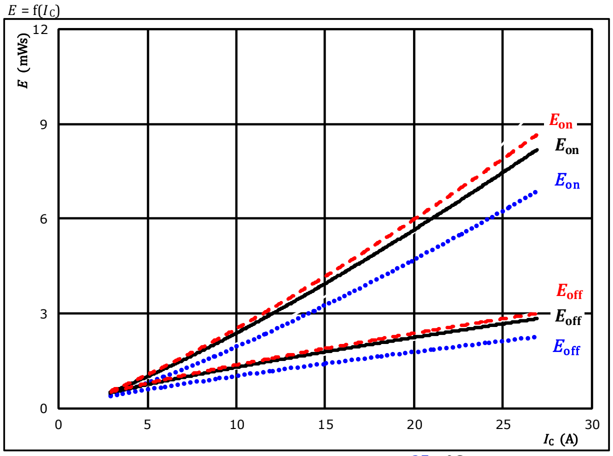
P_{rec} (100%) =	15,13	kW
E_{rec} (100%) =	1,45	mJ
t_{Erec} =	0,73	µs

Brake Switching Characteristics

figure 1. **IGBT**

Typical switching energy losses as a function of collector current

$E = f(I_C)$



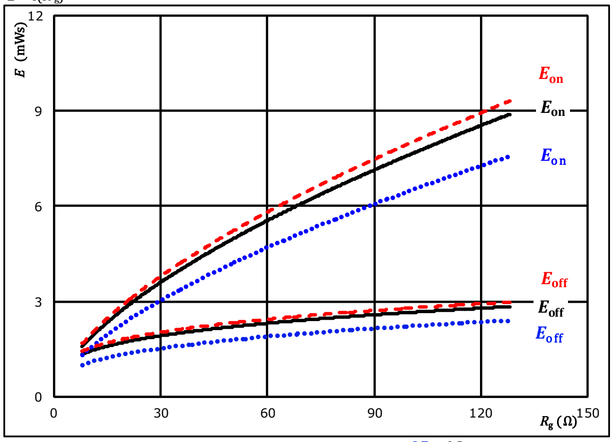
With an inductive load at

V_{CE} =	700	V	T_j:	25 °C	....
V_{GE} =	15/0	V		125 °C	———
R_{gon} =	32	Ω		150 °C	– – –
R_{goff} =	32	Ω			

figure 2. **IGBT**

Typical switching energy losses as a function of gate resistor

$E = f(R_g)$



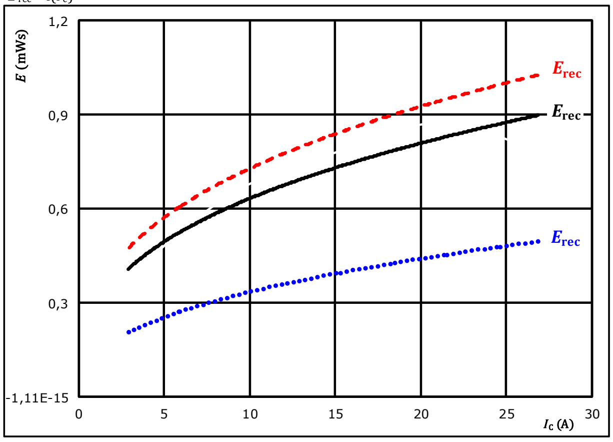
With an inductive load at

V_{CE} =	700	V	T_j:	25 °C	....
V_{GE} =	15/0	V		125 °C	———
I_C =	15	A		150 °C	– – –

figure 3. **FWD**

Typical reverse recovered energy loss as a function of collector current

$E_{rec} = f(I_C)$



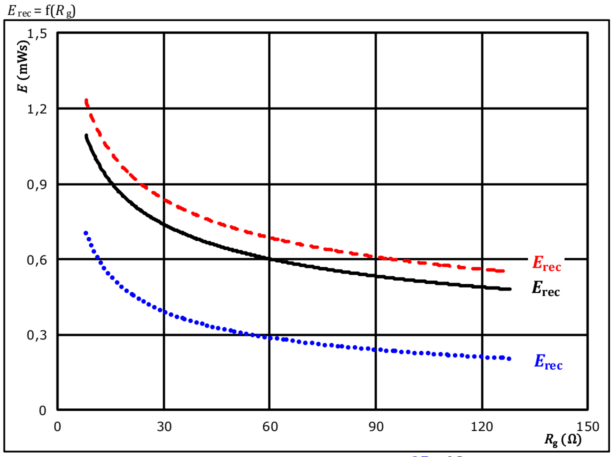
With an inductive load at

V_{CE} =	700	V	T_j:	25 °C	....
V_{GE} =	15/0	V		125 °C	———
R_{gon} =	32	Ω		150 °C	– – –

figure 4. **FWD**

Typical reverse recovered energy loss as a function of gate resistor

$E_{rec} = f(R_g)$



With an inductive load at

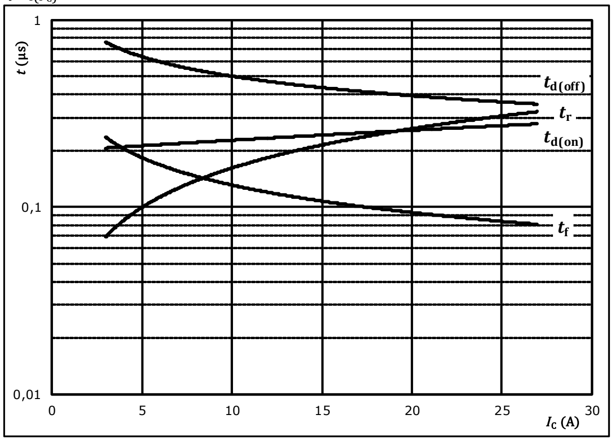
V_{CE} =	700	V	T_j:	25 °C	....
V_{GE} =	15/0	V		125 °C	———
I_C =	15	A		150 °C	– – –

Brake Switching Characteristics

figure 5. **IGBT**

Typical switching times as a function of collector current

$t = f(I_C)$



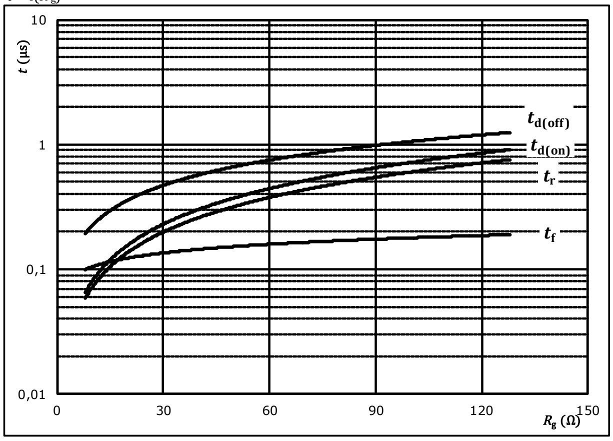
With an inductive load at

T_j =	150	°C
V_{CE} =	700	V
V_{GE} =	15/0	V
R_{gon} =	32	Ω
R_{goff} =	32	Ω

figure 6. **IGBT**

Typical switching times as a function of gate resistor

$t = f(R_g)$



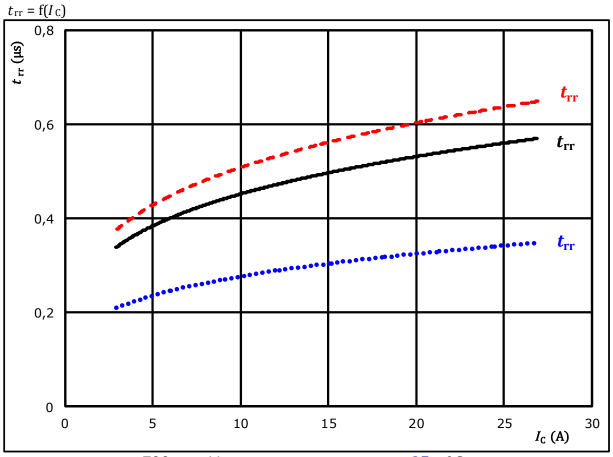
With an inductive load at

T_j =	150	°C
V_{CE} =	700	V
V_{GE} =	15/0	V
I_C =	15	A

figure 7. **FWD**

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$

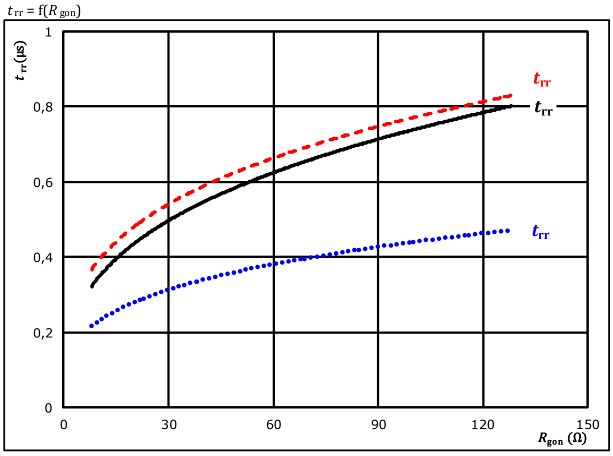


At V_{CE} =	700	V		25	°C
V_{GE} =	15/0	V	T_j:	125	°C
R_{gon} =	32	Ω		150	°C

figure 8. **FWD**

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



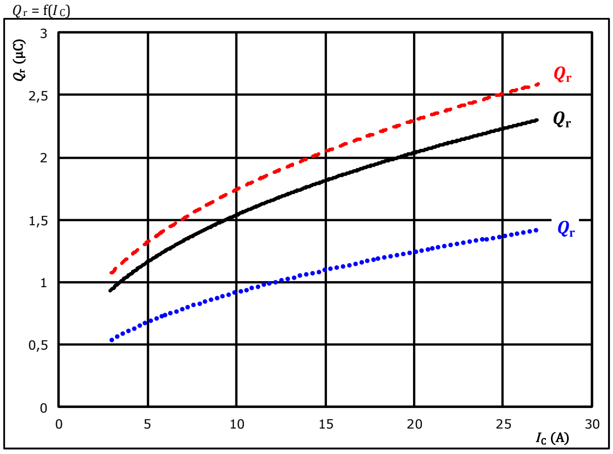
At V_{CE} =	700	V		25	°C
V_{GE} =	15/0	V	T_j:	125	°C
I_C =	15	A		150	°C

Brake Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$Q_r = f(I_C)$

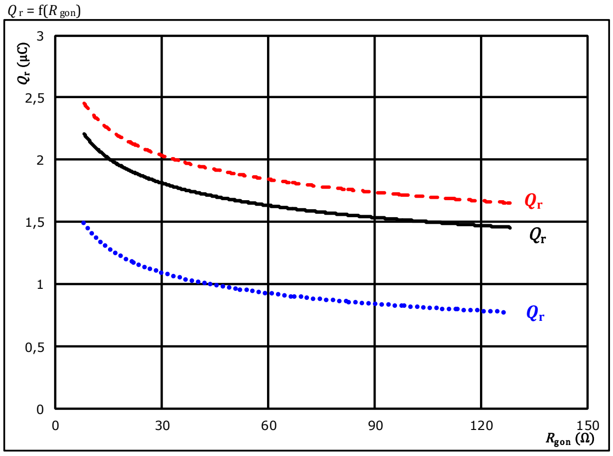


At						
V_{CE} =	700	V		25	°C	dotted
V_{GE} =	15/0	V	T_j:	125	°C	solid
R_{gon} =	32	Ω		150	°C	dashed

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$Q_r = f(R_{gon})$

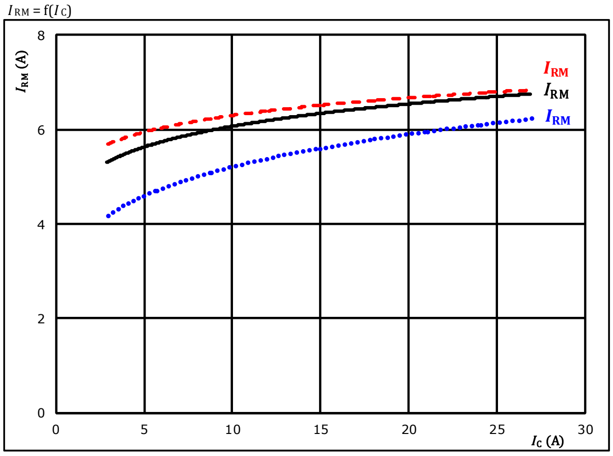


At						
V_{CE}=	700	V		25	°C	dotted
V_{GE} =	15/0	V	T_j:	125	°C	solid
I_C=	15	A		150	°C	dashed

figure 11. FWD

Typical peak reverse recovery current current as a function of collector current

$I_{RM} = f(I_C)$

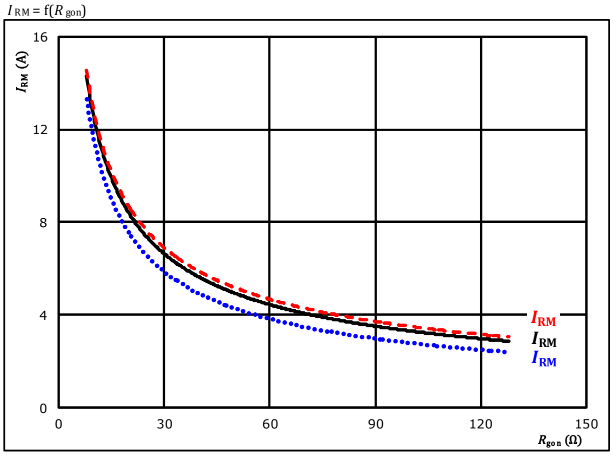


At						
V_{CE}:	700	V		25	°C	dotted
V_{GE} =	15/0	V	T_j:	125	°C	solid
R_{gon} =	32	Ω		150	°C	dashed

figure 12. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$I_{RM} = f(R_{gon})$



At						
V_{CE} =	700	V		25	°C	dotted
V_{GE} =	15/0	V	T_j:	125	°C	solid
I_C =	15	A		150	°C	dashed

Vincotech

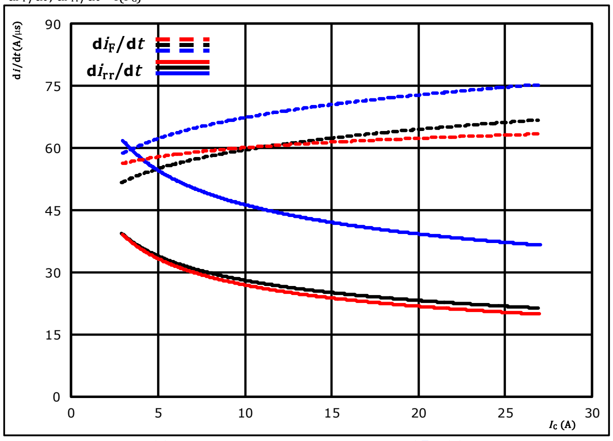
10-FY12PMA025M7-P588A78 /
10-PY12PMA025M7-P588A78Y /
10-F112PMA025M7-P588A79
datasheet

Brake Switching Characteristics

figure 13. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_F/dt, di_{rr}/dt = f(I_C)$



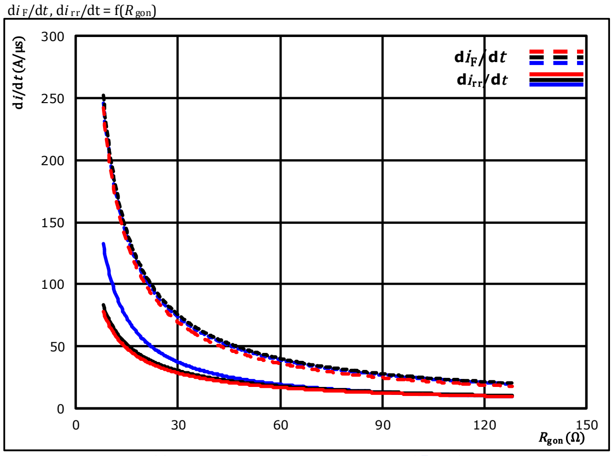
At

V_{CE} =	700	V		25	°C
V_{GE} =	15/0	V	T_j:	125	°C
R_{gon} =	32	Ω		150	°C

figure 14. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$di_F/dt, di_{rr}/dt = f(R_{gon})$



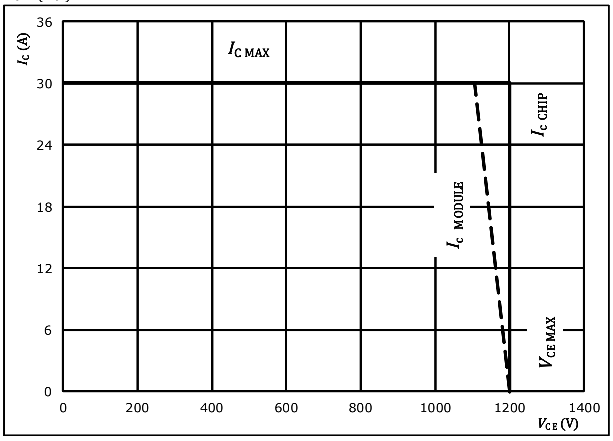
At

V_{CE} =	700	V		25	°C
V_{GE} =	15/0	V	T_j:	125	°C
I_C=	15	A		150	°C

figure 15. **IGBT**

Reverse bias safe operating area

$I_C = f(V_{CE})$



At

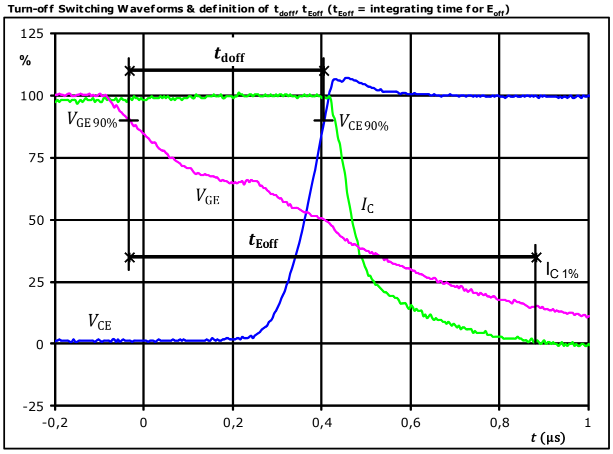
T_j =	175	°C
R_{gon} =	32	Ω
R_{goff} =	32	Ω

Brake Switching Definitions

General conditions		
T_j	=	125 °C
R_{gon}	=	32 Ω
R_{goff}	=	32 Ω

figure 1. **IGBT**

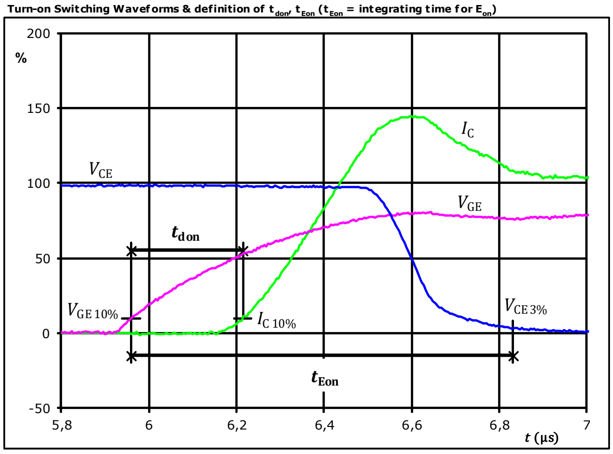
Turn-off Switching Waveforms & definition of t_{doff}, t_{Eoff} (t_{Eoff} = integrating time for E_{off})



$V_{GE}(0\%)$ =	0	V
$V_{GE}(100\%)$ =	15	V
$V_C(100\%)$ =	700	V
$I_C(100\%)$ =	15	A
t_{doff} =	0,442	µs
t_{Eoff} =	0,915	µs

figure 2. **IGBT**

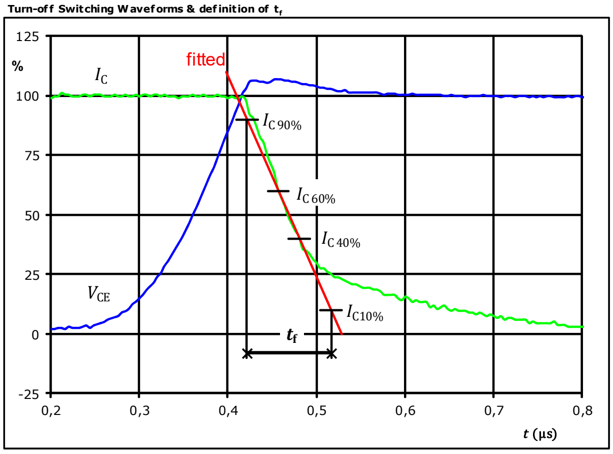
Turn-on Switching Waveforms & definition of t_{don}, t_{Eon} (t_{Eon} = integrating time for E_{on})



$V_{GE}(0\%)$ =	0	V
$V_{GE}(100\%)$ =	15	V
$V_C(100\%)$ =	700	V
$I_C(100\%)$ =	15	A
t_{don} =	0,257	µs
t_{Eon} =	0,872	µs

figure 3. **IGBT**

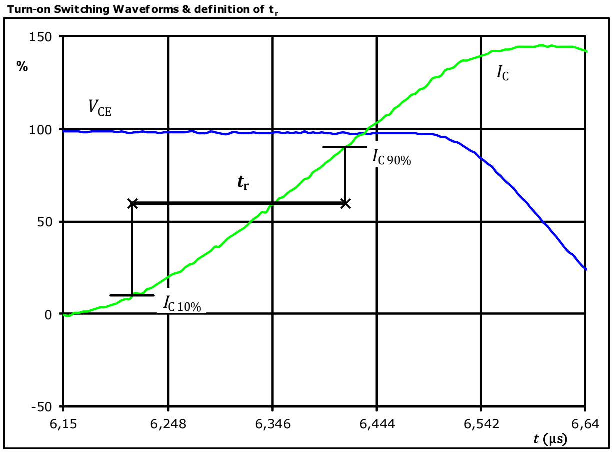
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%)$ =	700	V
$I_C(100\%)$ =	15	A
t_f =	0,088	µs

figure 4. **IGBT**

Turn-on Switching Waveforms & definition of t_r

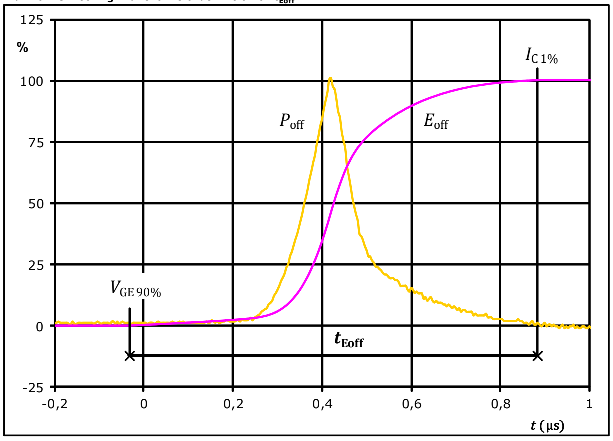


$V_C(100\%)$ =	700	V
$I_C(100\%)$ =	15	A
t_r =	0,200	µs

Brake Switching Characteristics

figure 5. **IGBT**

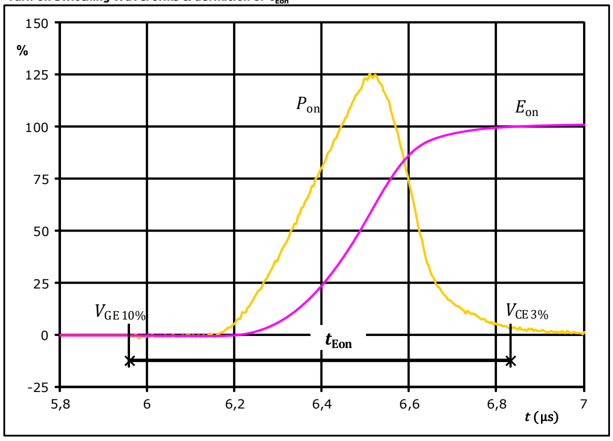
Turn-off Switching Waveforms & definition of t_{Eoff}



P_{off} (100%) =	10,55	kW
E_{off} (100%) =	1,71	mJ
t_{Eoff} =	0,92	µs

figure 6. **IGBT**

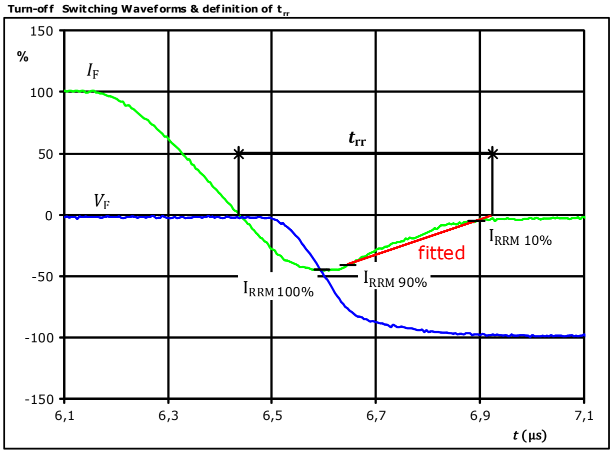
Turn-on Switching Waveforms & definition of t_{Eon}



P_{on} (100%) =	10,55	kW
E_{on} (100%) =	3,57	mJ
t_{Eon} =	0,87	µs

figure 7. **FWD**

Turn-off Switching Waveforms & definition of t_{rr}

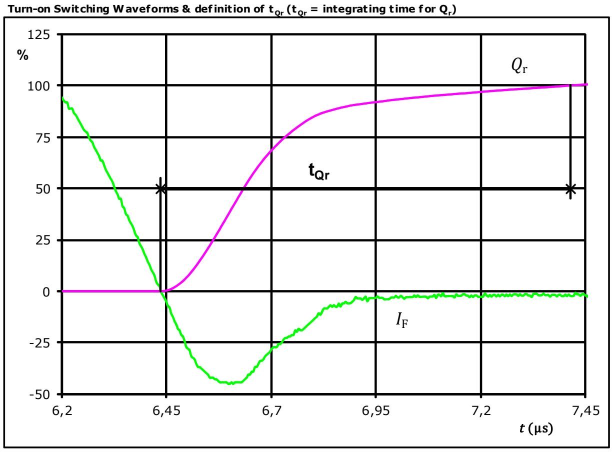


V_F (100%) =	700	V
I_F (100%) =	15	A
I_{RRM} (100%) =	-7	A
t_{rr} =	0,485	µs

Brake Switching Characteristics

figure 8. **FWD**

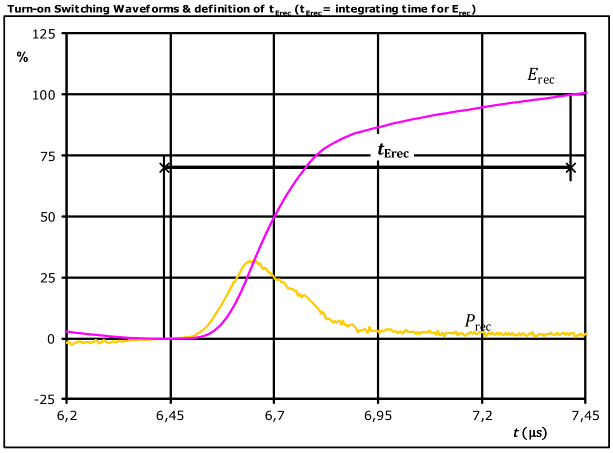
Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)



I_F (100%) =	15	A
Q_r (100%) =	1,88	µC
t_{Qr} =	0,98	µs

figure 9. **FWD**

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})



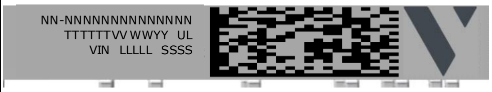
P_{rec} (100%) =	10,55	kW
E_{rec} (100%) =	0,78	mJ
t_{Erec} =	0,98	µs

10-FY12PMA025M7-P588A78 / 10-PY12PMA025M7-P588A78Y / 10-F112PMA025M7-P588A79

datasheet

Ordering Code & Marking

Version	Ordering Code
without thermal paste 12 mm housing with solder pins	10-FY12PMA025M7-P588A78
with thermal paste 12 mm housing with press-fit pins	10-PY12PMA025M7-P588A78Y-/3/
without thermal paste 17 mm housing with solder pins	10-F112PMA025M7-P588A79



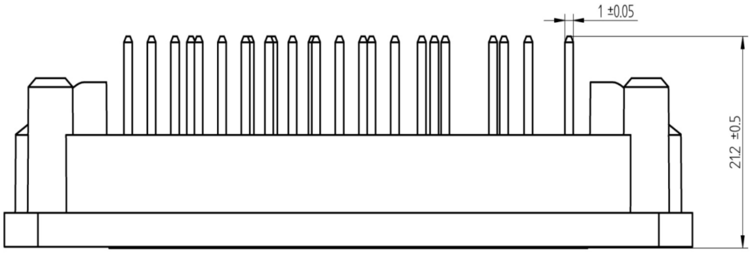
	Name		Date code	UL & VIN	Lot	Serial
Text	NN-NNNNNNNNNNNNNN-TTTTTTVV		WWYY	UL VIN	LLLLL	SSSS
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTTVV	LLLLL	SSSS	WWYY		

Outline

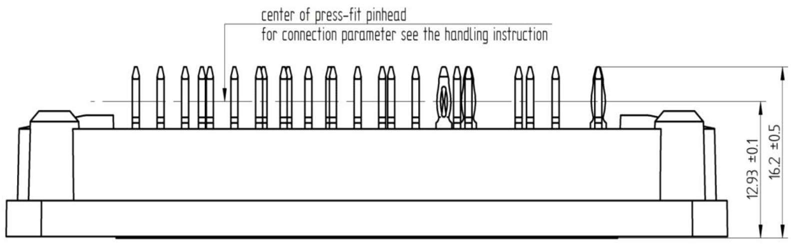
Pin table

Pin	X	Y	Function
1	52,55	0	G27
2	47,7	0	DC-Rect
3	44,8	0	DC-Rect
4	37,8	0	DC+Rect
5	37,8	2,8	DC+Rect
6	35	0	DC+Inv
7	35	2,8	DC+Inv
8	28	0	Therm1
9	25,2	0	Therm2
10	22,4	0	DC-3
11	19,6	0	G15
12	16,8	0	S15
13	14	0	DC-2
14	11,2	0	G13
15	8,4	0	S13
16	5,6	0	DC-1
17	2,8	0	G11
18	0	0	S11
19	0	28,5	Ph1
20	2,8	28,5	G12
21	7,5	28,5	S12
22	14,5	28,5	Ph2
23	17,3	28,5	G14
24	22	28,5	S14
25	29	28,5	Ph3
26	31,8	28,5	G16
27	36,5	28,5	S16
28	43,5	28,5	ACIn1
29	52,55	25	ACIn2
30	52,55	16,9	ACIn3
31	52,55	8,6	Br
32	52,55	2,8	DC-Br

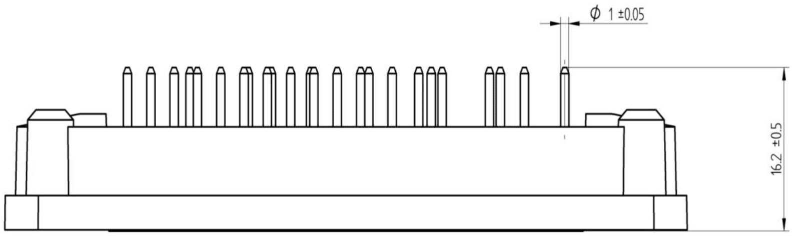
P588A79

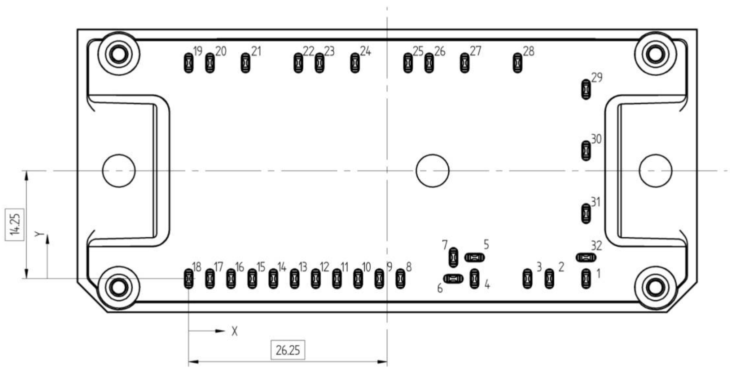


P588A78Y



P588A78





Tolerance of pinpositions: ±0,5mm at the end of pins
Dimension of coordinate axis is only offset without tolerance

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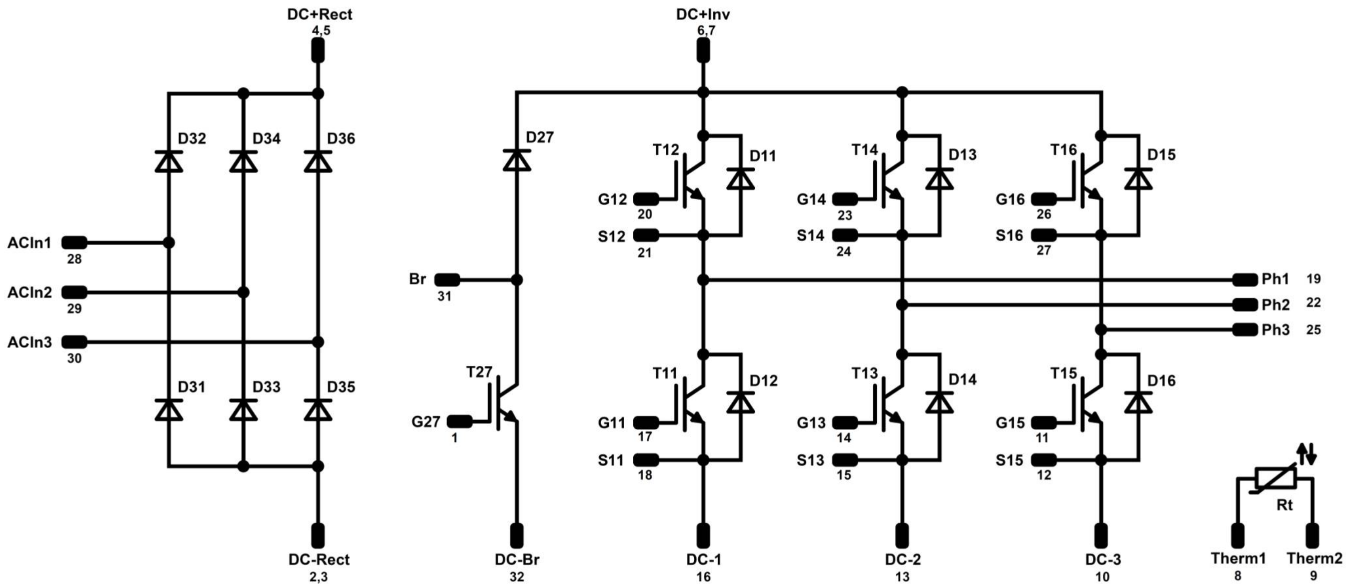
Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
D31, D32, D33, D34, D35, D36	Rectifier	1600 V	35 A	Rectifier Diode	
T11, T12, T13, T14, T15, T16	IGBT	1200 V	25 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	1200 V	25 A	Inverter Diode	
T27	IGBT	1200 V	15 A	Brake Switch	
D27	FWD	1200 V	10 A	Brake Diode	
Rt	NTC			Thermistor	

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for *flow* 1 packages see vincotech.com website.

Package data
Package data for *flow* 1 packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.

Document No.:	Date:	Modification:	Pages
10-xY12PMA025M7-P588A7xx-D1-14	27 Nov. 2017		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.